



1. Description

1.1. Project

Project Name	explore
Board Name	custom
Generated with:	STM32CubeMX 6.2.0
Date	12/06/2023

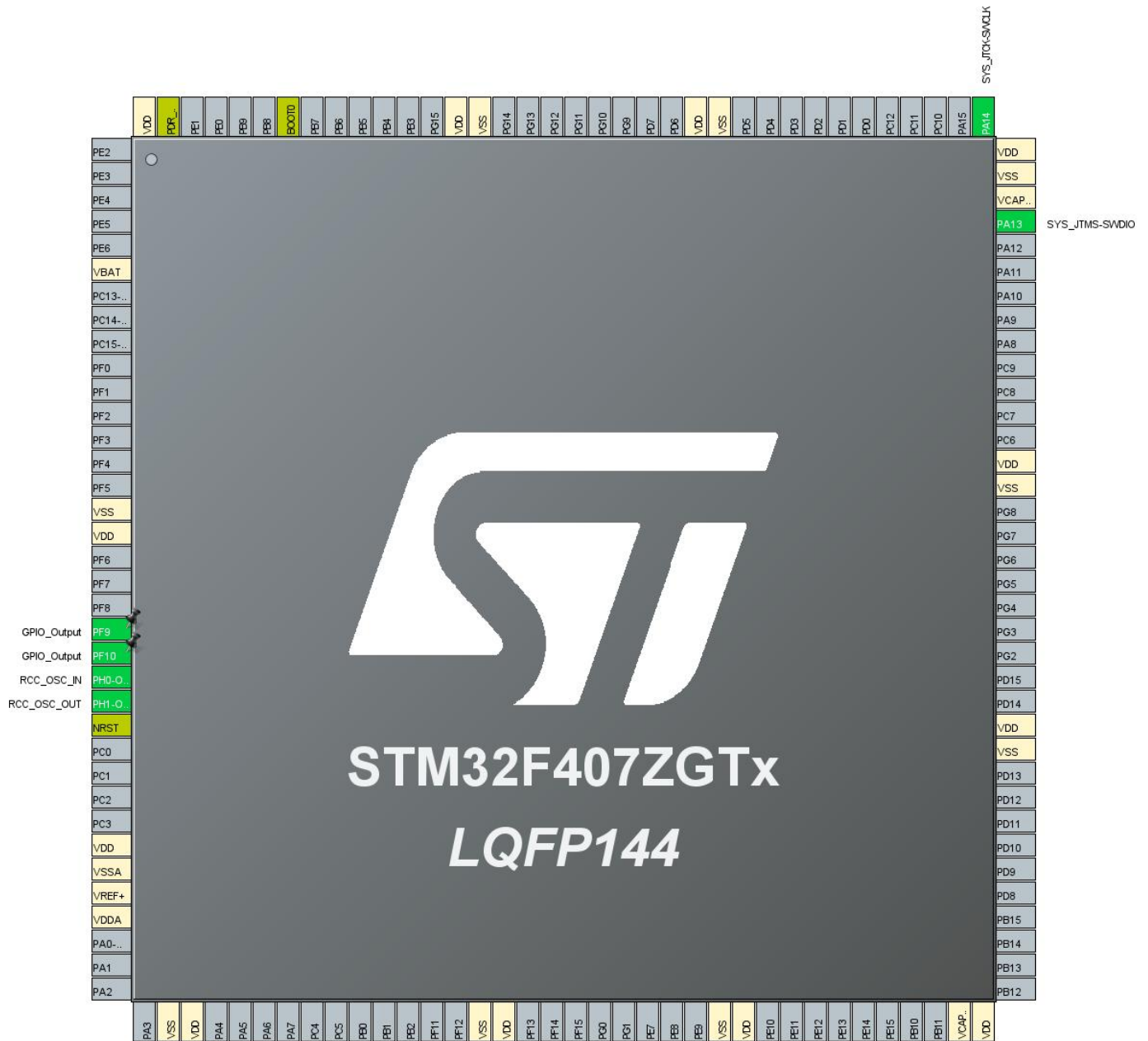
1.2. MCU

MCU Series	STM32F4
MCU Line	STM32F407/417
MCU name	STM32F407ZGTx
MCU Package	LQFP144
MCU Pin number	144

1.3. Core(s) information

Core(s)	Arm Cortex-M4
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2. Pinout Configuration

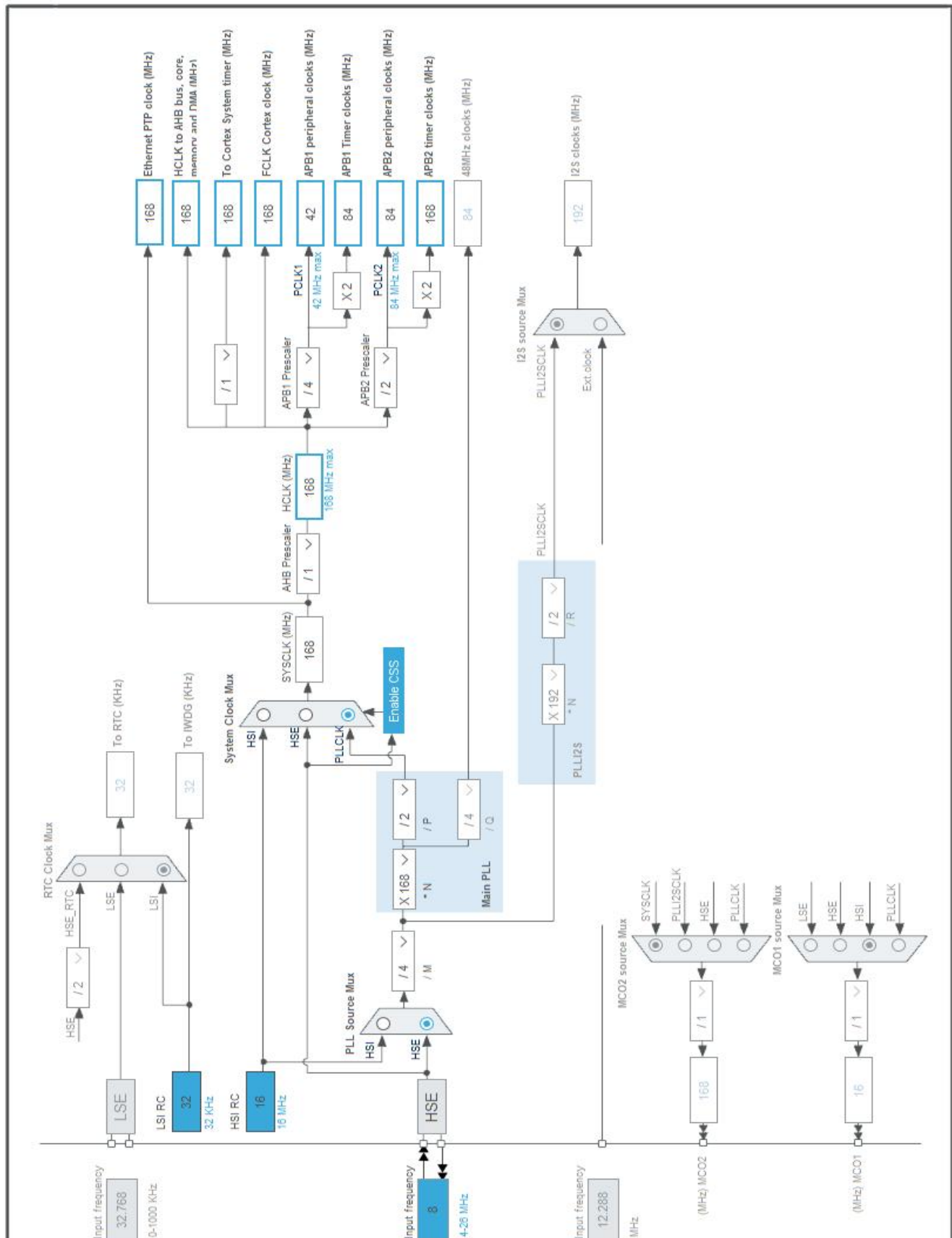


3. Pins Configuration

Pin Number LQFP144	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
6	VBAT	Power		
16	VSS	Power		
17	VDD	Power		
21	PF9 *	I/O	GPIO_Output	
22	PF10 *	I/O	GPIO_Output	
23	PH0-OSC_IN	I/O	RCC_OSC_IN	
24	PH1-OSC_OUT	I/O	RCC_OSC_OUT	
25	NRST	Reset		
30	VDD	Power		
31	VSSA	Power		
32	VREF+	Power		
33	VDDA	Power		
38	VSS	Power		
39	VDD	Power		
51	VSS	Power		
52	VDD	Power		
61	VSS	Power		
62	VDD	Power		
71	VCAP_1	Power		
72	VDD	Power		
83	VSS	Power		
84	VDD	Power		
94	VSS	Power		
95	VDD	Power		
105	PA13	I/O	SYS_JTMS-SWDIO	
106	VCAP_2	Power		
107	VSS	Power		
108	VDD	Power		
109	PA14	I/O	SYS_JTCK-SWCLK	
120	VSS	Power		
121	VDD	Power		
130	VSS	Power		
131	VDD	Power		
138	BOOT0	Boot		
143	PDR_ON	Reset		
144	VDD	Power		

* The pin is affected with an I/O function

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value
Project Name	explore
Project Folder	D:\STM32Project\explore
Toolchain / IDE	STM32CubeIDE
Firmware Package Name and Version	STM32Cube FW_F4 V1.26.2
Application Structure	Advanced
Generate Under Root	Yes
Do not generate the main()	No
Minimum Heap Size	0x200
Minimum Stack Size	0x400

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy only the necessary library files
Generate peripheral initialization as a pair of '.c/.h' files	No
Backup previously generated files when re-generating	No
Keep User Code when re-generating	Yes
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power consumption)	No
Enable Full Assert	No

5.3. Advanced Settings - Generated Function Calls

Rank	Function Name	Peripheral Instance Name
1	MX_GPIO_Init	GPIO
2	SystemClock_Config	RCC

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32F4
Line	STM32F407/417
MCU	STM32F407ZGTx
Datasheet	DS8626_Rev8

6.2. Parameter Selection

Temperature	25
Vdd	3.3

6.3. Battery Selection

Battery	Li-SOCL2(A3400)
Capacity	3400.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	100.0 mA
Max Pulse Current	200.0 mA
Cells in series	1
Cells in parallel	1

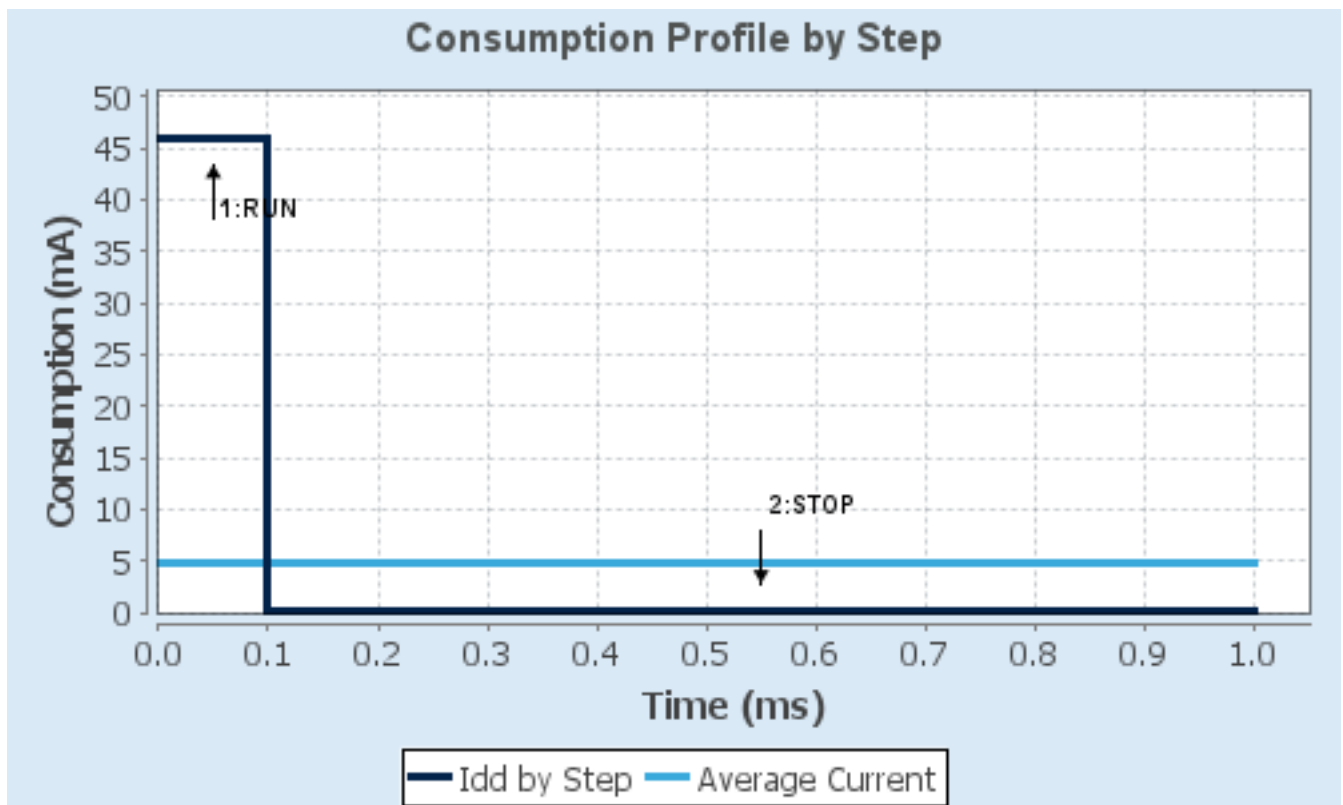
6.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.3	3.3
Voltage Source	Battery	Battery
Range	Scale1-High	No Scale
Fetch Type	FLASH	n/a
CPU Frequency	168 MHz	0 Hz
Clock Configuration	HSE PLL	Regulator LP Flash-PwrDwn
Clock Source Frequency	4 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	46 mA	280 μ A
Duration	0.1 ms	0.9 ms
DMIPS	210.0	0.0
Ta Max	98.93	104.96
Category	In DS Table	In DS Table

6.5. Results

Sequence Time	1 ms	Average Current	4.85 mA
Battery Life	29 days, 4 hours	Average DMIPS	210.0 DMIPS

6.6. Chart



7. *Peripherals and Middlewares Configuration*

7.1. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

7.1.1. Parameter Settings:

System Parameters:

VDD voltage (V)	3.3
Instruction Cache	Enabled
Prefetch Buffer	Enabled
Data Cache	Enabled
Flash Latency(WS)	5 WS (6 CPU cycle)

RCC Parameters:

HSI Calibration Value	16
HSE Startup Timeout Value (ms)	100
LSE Startup Timeout Value (ms)	5000

Power Parameters:

Power Regulator Voltage Scale	Power Regulator Voltage Scale 1
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7.2. SYS

Debug: Serial Wire

Timebase Source: SysTick

* User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PH0-OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PH1-OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SYS	PA13	SYS_JTMS-SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK-SWCLK	n/a	n/a	n/a	
GPIO	PF9	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	
	PF10	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

8.3.1. NVIC

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
Memory management fault	true	0	0
Pre-fetch fault, memory access fault	true	0	0
Undefined instruction or illegal state	true	0	0
System service call via SWI instruction	true	0	0
Debug monitor	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash global interrupt	unused		
RCC global interrupt	unused		
FPU global interrupt	unused		

8.3.2. NVIC Code generation

Enabled interrupt Table	Select for init sequence ordering	Generate IRQ handler	Call HAL handler
Non maskable interrupt	false	true	false
Hard fault interrupt	false	true	false
Memory management fault	false	true	false
Pre-fetch fault, memory access fault	false	true	false
Undefined instruction or illegal state	false	true	false
System service call via SWI instruction	false	true	false
Debug monitor	false	true	false
Pendable request for system service	false	true	false
System tick timer	false	true	true

* User modified value

9. System Views

9.1. Category view

9.1.1. Current

Middleware

System Core

Analog

Timers

Connectivity

Multimedia

Security

Computing

DMA

GPIO 

NVIC 

RCC 

SYS 

10. Docs & Resources

Type	Link
Datasheet	http://www.st.com/resource/en/datasheet/DM00037051.pdf
Reference manual	http://www.st.com/resource/en/reference_manual/DM00031020.pdf
Programming manual	http://www.st.com/resource/en/programming_manual/DM00046982.pdf
Errata sheet	http://www.st.com/resource/en/errata_sheet/DM00037591.pdf
Application note	http://www.st.com/resource/en/application_note/CD00167594.pdf
Application note	http://www.st.com/resource/en/application_note/CD00211314.pdf
Application note	http://www.st.com/resource/en/application_note/CD00249778.pdf
Application note	http://www.st.com/resource/en/application_note/CD00259245.pdf
Application note	http://www.st.com/resource/en/application_note/CD00264321.pdf
Application note	http://www.st.com/resource/en/application_note/CD00264342.pdf
Application note	http://www.st.com/resource/en/application_note/CD00264379.pdf
Application note	http://www.st.com/resource/en/application_note/DM00024853.pdf
Application note	http://www.st.com/resource/en/application_note/DM00025071.pdf
Application note	http://www.st.com/resource/en/application_note/DM00040802.pdf
Application note	http://www.st.com/resource/en/application_note/DM00040808.pdf
Application note	http://www.st.com/resource/en/application_note/DM00042534.pdf
Application note	http://www.st.com/resource/en/application_note/DM00046011.pdf
Application note	http://www.st.com/resource/en/application_note/DM00050879.pdf
Application note	http://www.st.com/resource/en/application_note/DM00072315.pdf
Application note	http://www.st.com/resource/en/application_note/DM00073742.pdf
Application note	http://www.st.com/resource/en/application_note/DM00073853.pdf
Application note	http://www.st.com/resource/en/application_note/DM00080497.pdf
Application note	http://www.st.com/resource/en/application_note/DM00081379.pdf
Application note	http://www.st.com/resource/en/application_note/DM00115714.pdf
Application note	http://www.st.com/resource/en/application_note/DM00123028.pdf

Application note http://www.st.com/resource/en/application_note/DM00129215.pdf

Application note http://www.st.com/resource/en/application_note/DM00154959.pdf

Application note http://www.st.com/resource/en/application_note/DM00160482.pdf

Application note http://www.st.com/resource/en/application_note/DM00213525.pdf

Application note http://www.st.com/resource/en/application_note/DM00220769.pdf

Application note http://www.st.com/resource/en/application_note/DM00257177.pdf

Application note http://www.st.com/resource/en/application_note/DM00272912.pdf

Application note http://www.st.com/resource/en/application_note/DM00226326.pdf

Application note http://www.st.com/resource/en/application_note/DM00236305.pdf

Application note http://www.st.com/resource/en/application_note/DM00263732.pdf

Application note http://www.st.com/resource/en/application_note/DM00281138.pdf

Application note http://www.st.com/resource/en/application_note/DM00296349.pdf

Application note http://www.st.com/resource/en/application_note/DM00327191.pdf

Application note http://www.st.com/resource/en/application_note/DM00354244.pdf

Application note http://www.st.com/resource/en/application_note/DM00373474.pdf

Application note http://www.st.com/resource/en/application_note/DM00315319.pdf

Application note http://www.st.com/resource/en/application_note/DM00380469.pdf

Application note http://www.st.com/resource/en/application_note/DM00395696.pdf

Application note http://www.st.com/resource/en/application_note/DM00431633.pdf

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Application note http://www.st.com/resource/en/application_note/DM00536349.pdf

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